Electronic Patent Application Fee Transmittal							
Application Number:	10539223						
Filing Date:	01-Feb-2006						
Title of Invention:	Thin film transistor substrate and method for forming metal wire thereof						
First Named Inventor:	Jae-Gab Lee						
Filer:	Edward Chungfan Kwok/Jeannie Ha						
Attorney Docket Number:	AB-1448 US						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			120